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Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	40			
$R_{DS(on)}$ (Ω) at $V_{GS} = 10 \text{ V}$	0.00100			
I _D (A)	250			
Configuration	Single			
Package	TO-263-7L			

FEATURES

- TrenchFET® power MOSFET
- Package with low thermal resistance
- 100 % R_q and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



L	
G _O	_
N-Channel MOSFET	o _s

ABSOLUTE MAXIMUM RATING	S (T _C = 25 °C, unless	s otherwise noted	l)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	40	V	
Gate-source voltage		V _{GS}	± 20		
Continuous drain current	T _C = 25 °C ^a		250		
	T _C = 125 °C		229		
Continuous source current (diode conduction) ^a		Is	250	Α	
Pulsed drain current ^b	ed drain current ^b		420		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	78		
Single pulse avalanche energy	L = U.I IIII	E _{AS}	304	mJ	
Maximum power dissipation ^b	T _C = 25 °C	D	300	W	
	T _C = 125 °C	P _D	100	VV	
Operating junction and storage temperature	range	T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient P	PCB mount c	R_{thJA}	40	°C/W	
Junction-to-case (drain)		R_{thJC}	0.5		

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	DL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	40	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		3.0	3.5	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA
	I _{DSS}	V _{GS} = 0 V	V _{DS} = 40 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	500	μΑ
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	100	-	-	Α
Drain-source on-state resistance ^a		V _{GS} = 10 V	I _D = 40 A	-	0.00081	0.00100	
	R _{DS(on)}	V _{GS} = 10 V	I _D = 40 A, T _J = 125 °C	-	-	0.00152	Ω
		V _{GS} = 10 V	I _D = 40 A, T _J = 175 °C	-	-	0.00184	
Forward transconductance b	9 _{fs}	V _{DS}	= 15 V, I _D = 40 A	-	181	-	S
Dynamic ^b							
Input capacitance	C _{iss}	V _{GS} = 0 V	V _{DS} = 25 V, f = 1 MHz	-	10 841	15 000	pF
Output capacitance	C _{oss}			-	2928	4000	
Reverse transfer capacitance	C _{rss}			-	198	270	
Total gate charge ^c	Qg		V _{DS} = 20 V, I _D = 100 A	-	163	245	nC
Gate-source charge c	Q_{gs}	V _{GS} = 10 V		-	46	-	
Gate-drain charge ^c	Q _{gd}			-	36	-	İ
Gate resistance	R_g	f = 1 MHz		1	2.2	3.4	Ω
Turn-on delay time ^c	t _{d(on)}			-	24	40	
Rise time ^c	t _r	$V_{DD} = 20 \text{ V}, R_L = 0.2 \Omega$ $I_D \cong 100 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		-	215	330	no
Turn-off delay time ^c	t _{d(off)}			-	59	90	ns
Fall time ^c	t _f			-	35	55	
Source-Drain Diode Ratings and Chara	cteristics ^b						
Pulsed current ^a	I _{SM}			-	-	420	Α
Forward voltage	V_{SD}	I _F = 60 A, V _{GS} = 0 V		-	0.8	1.5	V
Body diode reverse recovery time	t _{rr}			-	92	185	ns
Body diode reverse recovery charge	Q _{rr}	I _F = 40 A, di/dt = 100 A/μs		-	198	400	nC
Reverse recovery fall time	ta			-	47	-	no
Reverse recovery rise time	t _b			-	45	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			_	-4.4	-	Α

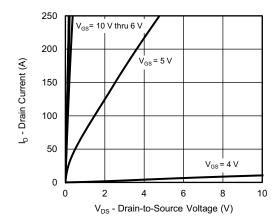
Notes

- a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

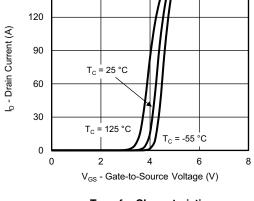
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

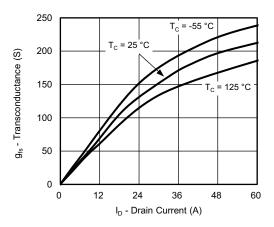


Output Characteristics

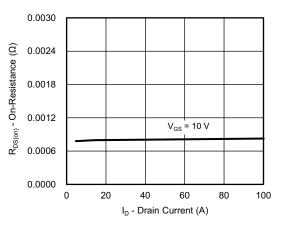


150

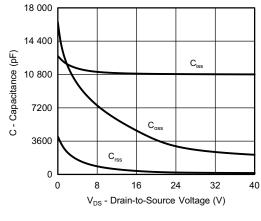
Transfer Characteristics



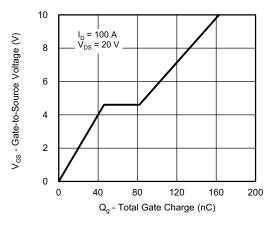
Transconductance



On-Resistance vs. Drain Current



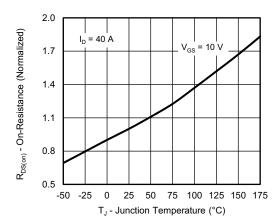
Capacitance



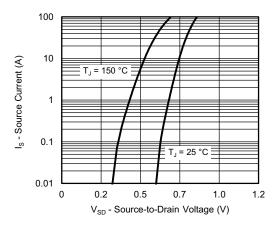
Gate Charge



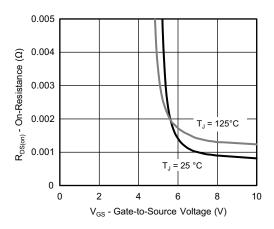
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



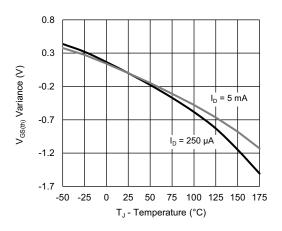
On-Resistance vs. Junction Temperature



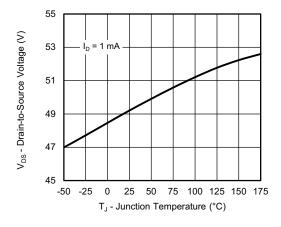
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

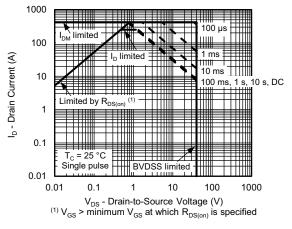


Drain Source Breakdown vs. Junction Temperature

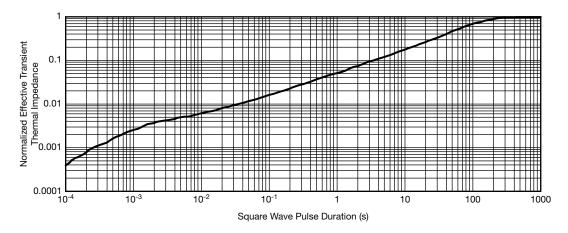
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THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



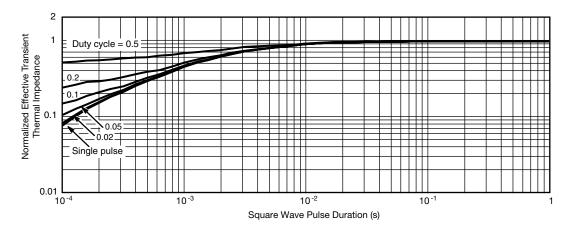
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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